

PHOTOCOUPLER PS9711

HIGH NOISE REDUCTION/HIGH-SPEED 10 Mbps, TOTEM-POLEOUTPUT TYPE5-PIN SOP TOM PHOTOCOUPLER-NEPOC[™] Series-

DESCRIPTION

The PS9711 is an optically coupled high-speed, totem-pole output isolator containing a GaAlAs LED on light emitting diode (input) and a photodiode and a signal processing circuit on light receiving side (output side) on one chip.

FEATURES

- High common mode transient immunity (CMH, CML = $\pm 10 \text{ kV}/\mu \text{s TYP.}$)
- Small package (5-pin SOP)
- High-speed response (tPHL = 30 ns, tPLH = 35 ns TYP.)
 - Pulse width distortion ($|t_{PHL} t_{PLH}| = 7 \text{ ns TYP.}$)
 - Totem-pole output (No pull-up resistor required)
 - Ordering number of taping product: PS9711-E3, E4: 900 pcs/reel,

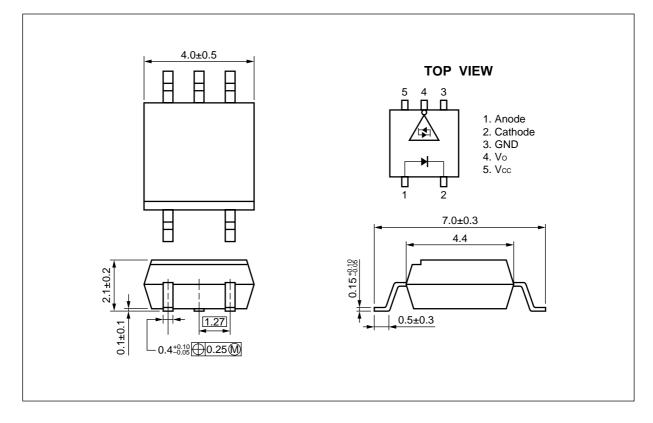
PS9711-F3, F4 (Recommended): 3 500 pcs/reel

APPLICATIONS

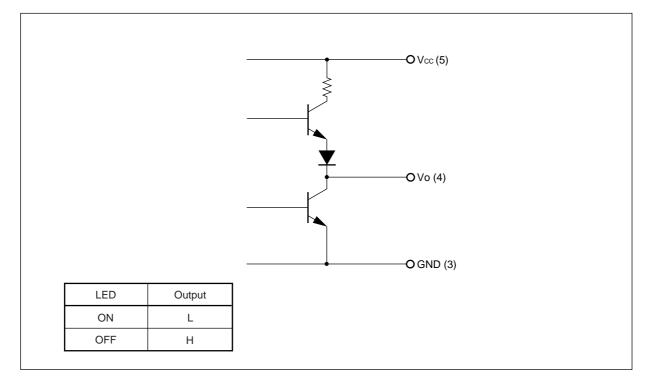
- · Computer and peripheral manufactures
- Measurement equipment
- PDP

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.





★ INTERNAL OUT PUT CIRCUIT



ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS9711	5-pin SOP	Magazine case 100 pcs	PS9711
PS9711-E3		Embossed Tape 900 pcs/reel	
PS9711-E4			
PS9711-F3		Embossed Tape 3 500 pcs/reel	
PS9711-F4			

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current	lF	30	mA
	Reverse Voltage	VR	3.0	V
Detector	Supply Voltage	Vcc	7	V
	Output Voltage	Vo	7	V
	High Level Output Current ^{*1}	Іон	-5	mA
	Low Level Output Current	Iol	13	mA
	Power Dissipation *1	Pc	130	mW
Isolation Voltage ^{*2}		BV	2 500	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-55 to +125	°C

*1 $T_A = -40$ to +85 °C

*2 AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output.

RECOMMENDED OPERATING CONDITIONS

1	1	٢	

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
High Level Input Current	IFH	7.5		12.5	mA
Low Level Input Current	FL	0		250	μA
Supply Voltage	Vcc	4.5	5.0	5.5	V
TTL (loads)	Ν			3	

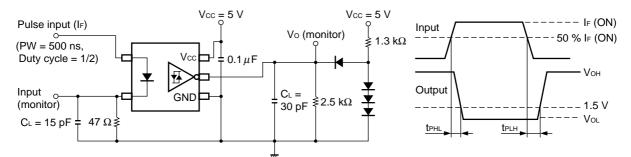
ELECTRICAL CHARACTERISTICS (T_A = -40 to +85 °C, unless otherwise specified)

	Parameter	Symbol	Cor	nditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, TA = 25 °C		1.4	1.65	1.9	V
	Reverse Current	R	Vr = 3 V, Ta = 25 °C				10	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25 °C			30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 5.5 V, IF = 250 μA			1	200	μA
	High Level Output Voltage	Vон	Vcc = 4.5 V, IF = 2	2.4	3.0		V	
	Low Level Output Voltage	Vol	Vcc = 4.5 V, IF = 7	Vcc = 4.5 V, IF = 7 mA, Io = 8 mA			0.6	V
	High Level Supply Current	Іссн	Vcc = 5.5 V, IF = 0) mA		11	17	mA
	Low Level Supply Current	Iccl	Vcc = 5.5 V, IF = 1	10 mA		12	18	mA
	High Level Output Short Circuit Current	Іоѕн	$V_{CC} = 5.5 \text{ V}, V_O = \text{GND}, I_F = 0 \text{ mA},$ 10 ms or less			-26		mA
	Low Level Output Short Circuit Current	Iosl	Vcc = Vo = 5.5 V, I⊧ = 8 mA, 10 ms or less			34		mA
Coupled	Threshold Input Current	FHL	Vcc = 5 V	TA = 25 °C		2.0	5	mA
	$(H \rightarrow L)$						6	
	Threshold Input Current	IFLH	Vcc = 5 V	T _A = 25 °C	0.5			mA
	$(L \rightarrow H)$				0.35			
	Isolation Resistance	Rı-o	$\label{eq:Vi-o} \begin{array}{l} V_{i\text{-}O} = 1 \ kV_{\text{DC}}, \ RH = 40 \ to \ 60 \ \%, \\ T_{\text{A}} = 25 \ ^{\circ}\text{C} \end{array}$		1011			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz, T _A = 25 °C			0.4		pF
	Propagation Delay Time	t PHL		T _A = 25 °C	15	30	65	ns
	$(H\toL)^{^{\star_2}}$		Vcc = 5 V, IF = 7.5 mA		10		85	
	Propagation Delay Time	tрін		T _A = 25 °C	15	35	65	ns
	$(L\toH)^{^{*2}}$		Vcc = 5 V, IF = 7.5 mA		10		85	
	Pulse Width Distortion (PWD) ²	tphl-tplh	Vcc = 5 V, IF = 7.5 mA			7	35	ns
	Common Mode Transient Immunity at High Level Output ^{*3}	СМн	$V_{CC} = 5 \text{ V}, \text{ TA} = 25 \text{ °C}, \text{ IF} = 0 \text{ mA},$ $V_{O (MIN.)} = 2 \text{ V}, \text{ V}_{CM} = 100 \text{ V}$		1	10		kV/µs
	Common Mode Transient Immunity at Low Level Output ^{'3}	CM∟			1	10		kV/µs

 \star

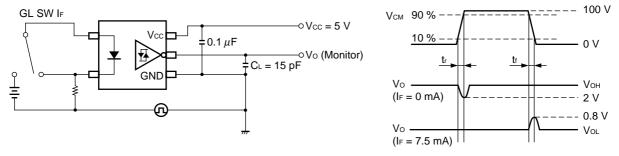
Data Sheet P13103EJ3V0DS00

- *1 Typical values at $T_A = 25 \ ^{\circ}C$
- *2 Test circuit for propagation delay time



C∟ is approximately which includes probe and stray wiring capacitance.

*3 Test circuit for common mode transient immunity

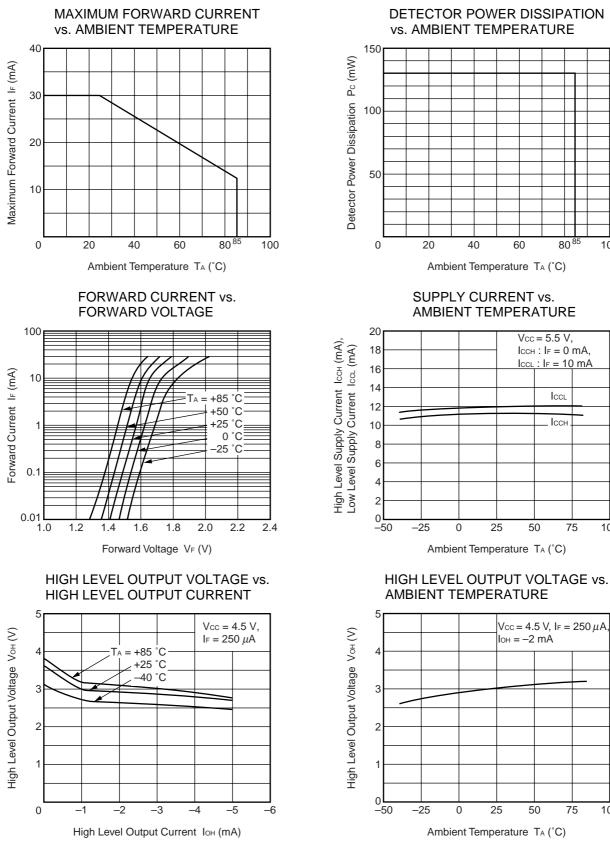


CL is approximately which includes probe and stray wiring capacitance.

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1 μ F is used between Vcc and GND near device.

TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)





40

0

25

25

0

50

75

100

50

Vcc = 4.5 V, IF = 250 µA

Iон = –2 mA

60

80⁸⁵

Vcc = 5.5 V,

ICCH : $I_F = 0 \text{ mA},$ ICCL : IF = 10 mA

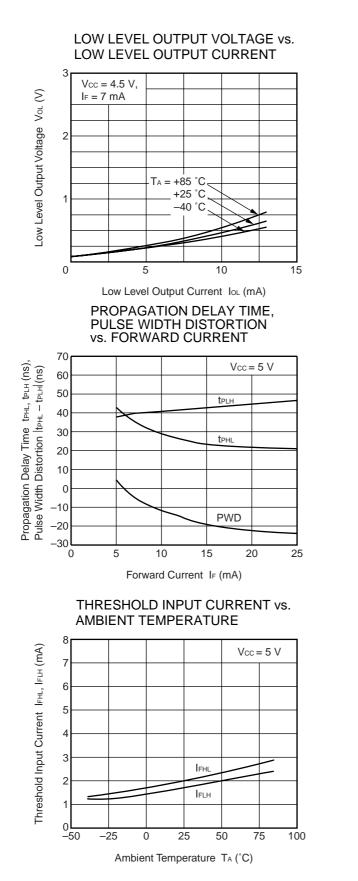
ICCL

Іссн

75

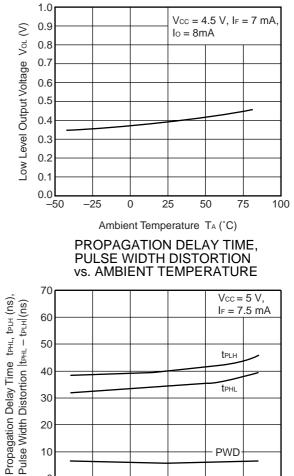
100

100



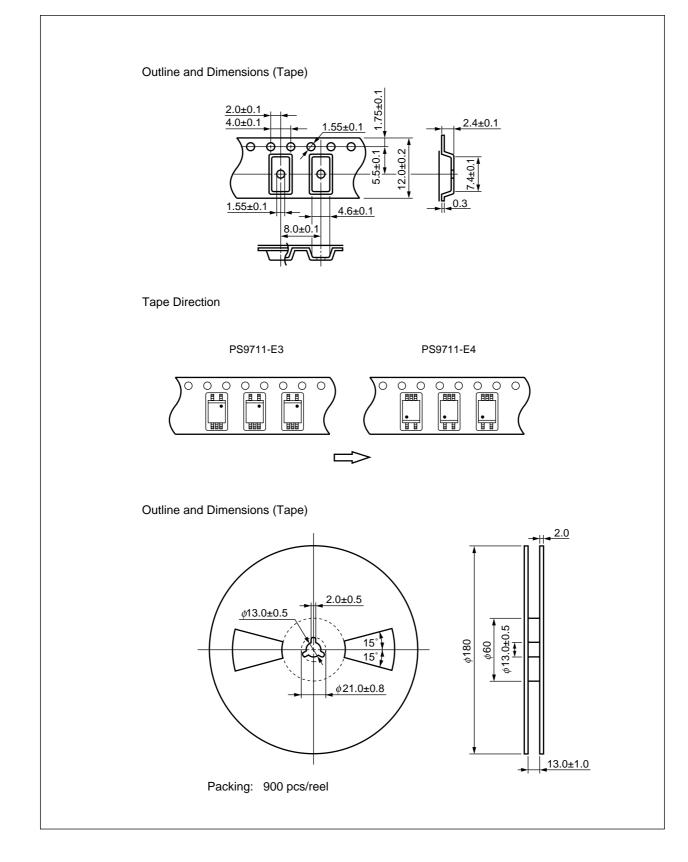
Remark The graphs indicate nominal characteristics.

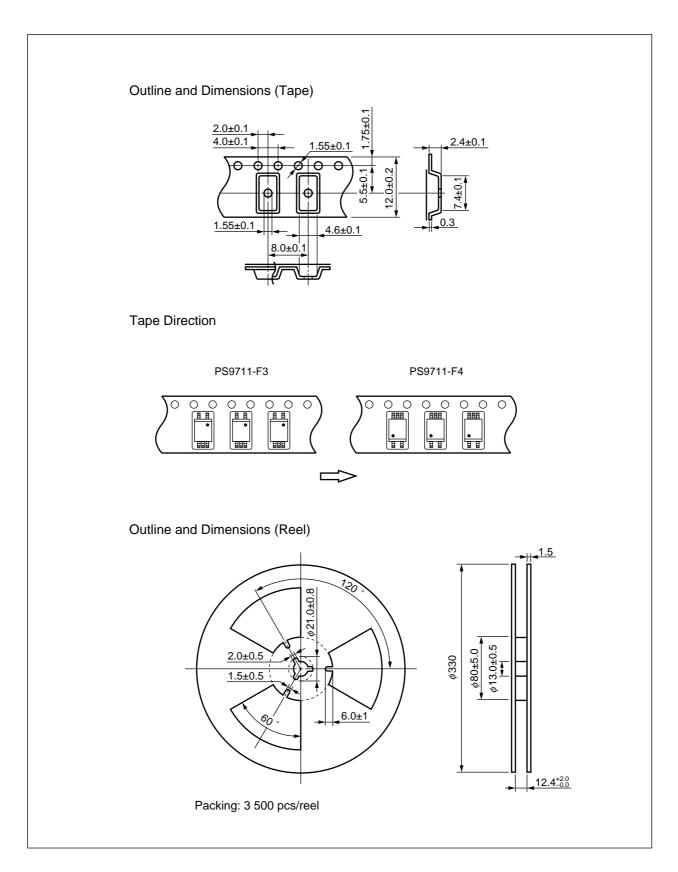
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



10 PWD 0 **–**50 -25 25 50 75 100 0 Ambient Temperature TA (°C)

★ TAPING SPECIFICATIONS (in millimeters)





RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
 - Peak reflow temperature 235 °C or below (package surface temperature)
 - Time of temperature higher than 210 °C
 - Number of reflows
 - Flux

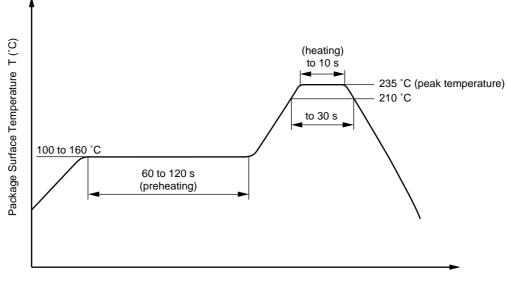
*

Three Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow

30 seconds or less





(2) Dip soldering

• Temperature

- 10 seconds or less
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)

260 °C or below (molten solder temperature)

• Flux

• Time

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

NEPOC is a trademark of NEC Corporation.

- The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.
- No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.
- NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.
- Descriptions of circuits, software, and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software, and information in the design of the customer's equipment shall be done under the full responsibility of the customer. NEC Corporation assumes no responsibility for any losses incurred by the customer or third parties arising from the use of these circuits, software, and information.
- While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.
- NEC devices are classified into the following three quality grades:
 "Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.
 - Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.